Rev. 1-10-03 Effective March 1998

## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

() Original () Supplemental () Substitute (X) PCT () DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## Title: SUBSTRATE HOLDING MECHANISM, SUBSTRATE POLISHING APPARATUS AND SUBSTRATE POLISHING METHOD

of which is described and claimed in:			
() the attached specification, or			
() the specification in application Serial No.	, filed	, and w	ith amendments through, or
(X) the specification in International Application No.	PCT/JP2003/017032,	filed December 26, 2003,	and as amended on June 16
2005 (if applicable).			

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2002-380583	December 27, 2002	YES
Japan	2003-188775	June 30, 2003	YES

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Huppert, Reg. No. 40,268; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office

## connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from YUASA & HARA as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to:		Direct Telephone Calls to:
	CUSTOMER NO. 000513	WENDEROTH, LIND & PONACK, L.L.P. 2033 "K" Street, N.W., Suite 800 Washington, D.C. 20006-1021  Phone:(202) 721-8200 Fax:(202) 721-8250
Full Name of First Inventor	FAMILY NAME FIRST GIVEN TOGAWA Tetsu	
Residence & Citizenship	cıty state or co Chigasaki-shi Japan	ountry country of citizenship  Japan
Post Office Address	ADDRESS CITY 3-1-46, Shorin, Chigasaki-shi,	state or country zip code Kanagawa 253-0017 Japan
Full Name of Second Inventor	FAMILY NAME FIRST GIVEN WATANABE Toshi	
Residence & Citizenship	CITY STATE OR CO. Tokyo Japan	untry country of citizenship Japan
Post Office Address	ADDRESS CITY 3-28-8, Shibamata, Katsushika	state or country zip code a-ku, Tokyo 125-0052 Japan
Full Name of Third Inventor	family name first given YANO Hiroy	
Residence & Citizenship	city state or con Yokohama-shi Japan	untry country of citizenship Japan
Post Office Address	address city 5-21-24, Nara, Aoba-ku, Yoko	state or country zip code bhama-shi, Kanagawa 227-0038 Japan
Full Name of Fourth Inventor	FAMILY NAME FIRST GIVEN TOYOTA Gen	N NAME SECOND GIVEN NAME
Residence & Citizenship	city state or col Yokohama-shi Japan	untry country of citizenship Japan
Post Office Address	ADDRESS CITY 2-39-1-305, Hatsune-cho, Nak	state or country zip code ta-ku, Yokohama-shi, Kanagawa 231-0053 Japan
Full Name of Fifth Inventor	family name first given IWADE Kenji	
Residence & Citizenship	city STATE OR CO. Hiratsuka-shi Japan	untry country of citizenship Japan

Post Office	ADDRESS	спу	state or country zip code	
Address	4-7-203, Nishiki-	cho, Hiratsuka-shi, Ka	anagawa 254-0044 Japan	
Full Name of Sixth Inventor	FAMILY NAME TATEYAMA	first given name Yoshikuni	SECOND GIVEN NAME	
Residence &	сту	state or country	country of citizenship	
Citizenship	Oita-shi	Japan	Japan	
Post Office Address	ADDRESS 2-8-23, Yokota, C	сіту Dita-shi, Oita 870-026	state or country zip code 3 Japan	

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor	Date
Tetsuji TOGAWA	
2nd Inventor	Date
Toshio WATANABE	
3rd Inventor	Date
Hiroyuki YANO	
4th Inventor	Date
Gen TOYOTA	
5th Inventor	Date
Kenji IWADE	
6th Inventor	Date
Yoshikuni TATEYAMA	
The above application may be more particularly identifi	ed as follows:
U.S. Application Serial No.	Filing Date June 16, 2005

Applicant Reference Number ME:FK, PC/E(X)-6-844US Atty Docket No. 2005-0993A

Title of Invention SUBSTRATE HOLDING MECHANISM, SUBSTRATE POLISHING APPARATUS AND SUBSTRATE POLISHING METHOD